

LN2502LT1G

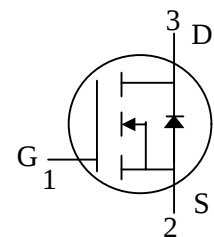
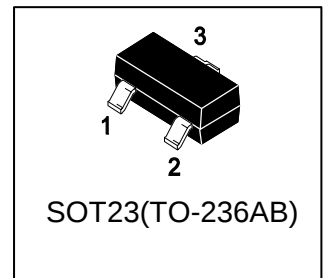
20V N-Channel Enhancement-Mode MOSFET

1. FEATURES

- $V_{DS} = 20V$
- $R_{DS(ON)}, V_{GS}@2.5V, I_{DS}@5.2A = 50m\Omega$
- $R_{DS(ON)}, V_{GS}@4.5V, I_{DS}@6A = 40m\Omega$
- We declare that the material of product compliance with RoHS requirements and Halogen Free.

2. DEVICE MARKING AND ORDERING INFORMATION

Device	Marking	Shipping
LN2502LT1G	N25	3000/Tape&Reel
LN2502LT3G	N25	10000/Tape&Reel



3. MAXIMUM RATINGS($T_a = 25^\circ C$)

Parameter	Symbol	Limits	Unit
Drain–Source Voltage	V_{DSS}	20	V
Gate–to–Source Voltage – Continuous	V_{GS}	± 12	V
Drain Current	I_D I_{DM}	6 33	A
– Continuous $T_A = 25^\circ C$			
– Pulsed(Note 1)			
Maximum Power Dissipation	P_D	1	W
Operating Junction and Storage Temperature Range	T_J/T_{stg}	$-55 \sim +150$	$^\circ C$

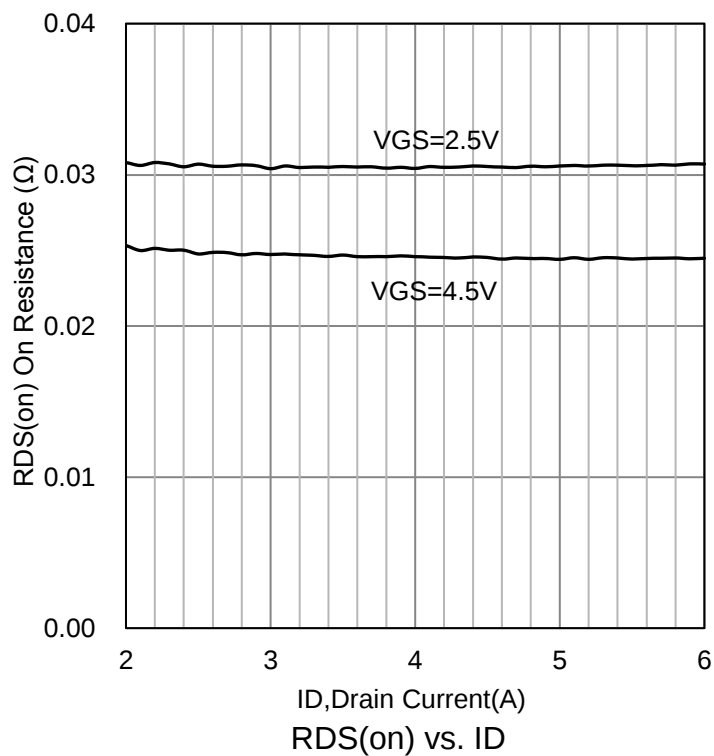
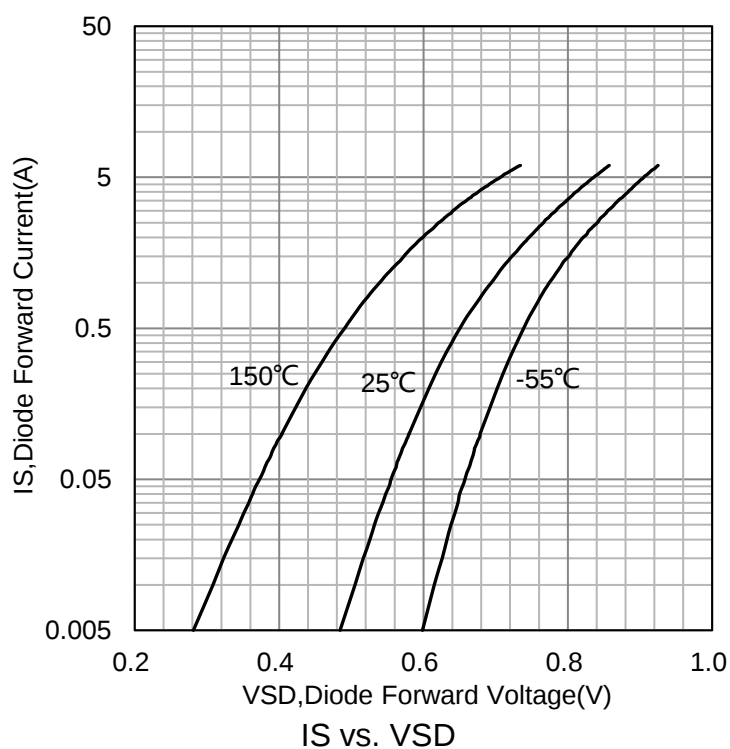
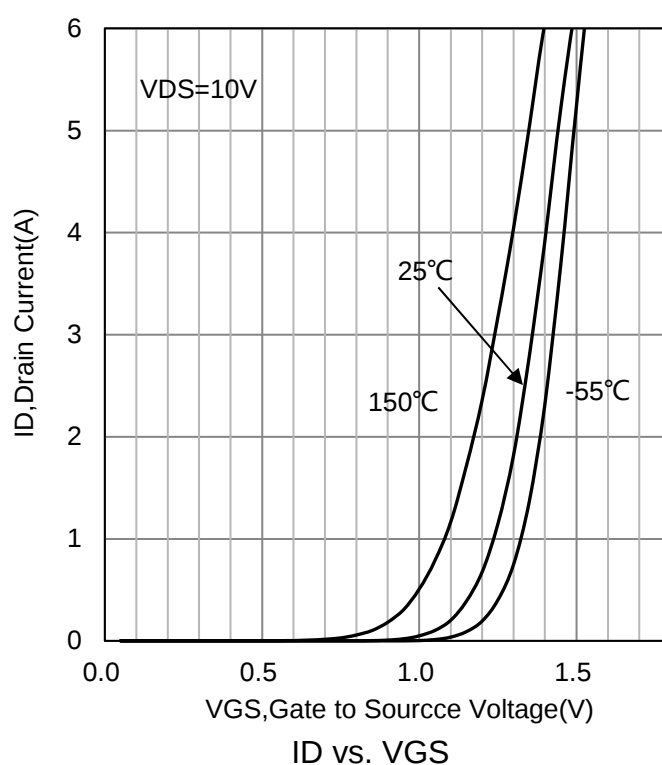
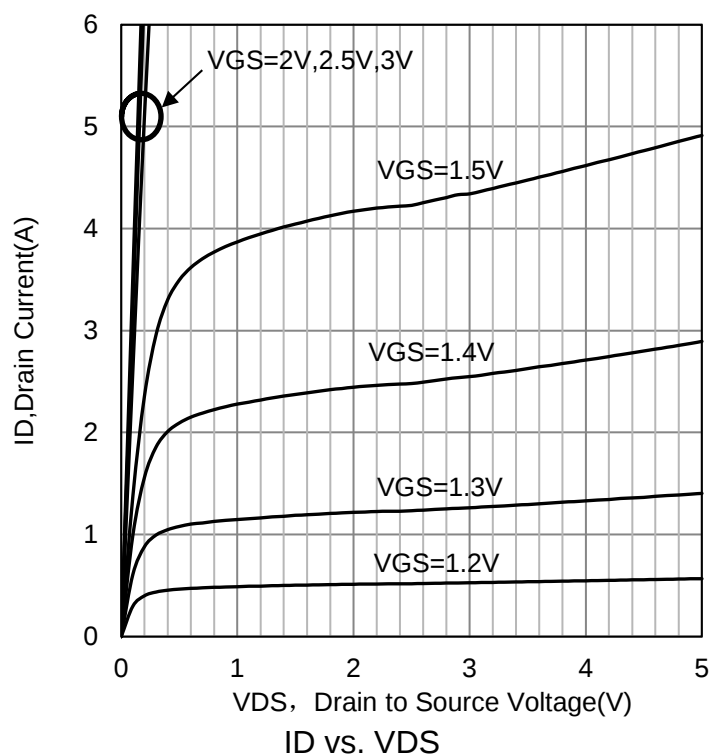
1. Repetitive Rating: Pulse width limited by the maximum junction temperature

4. ELECTRICAL CHARACTERISTICS (Ta= 25°C)

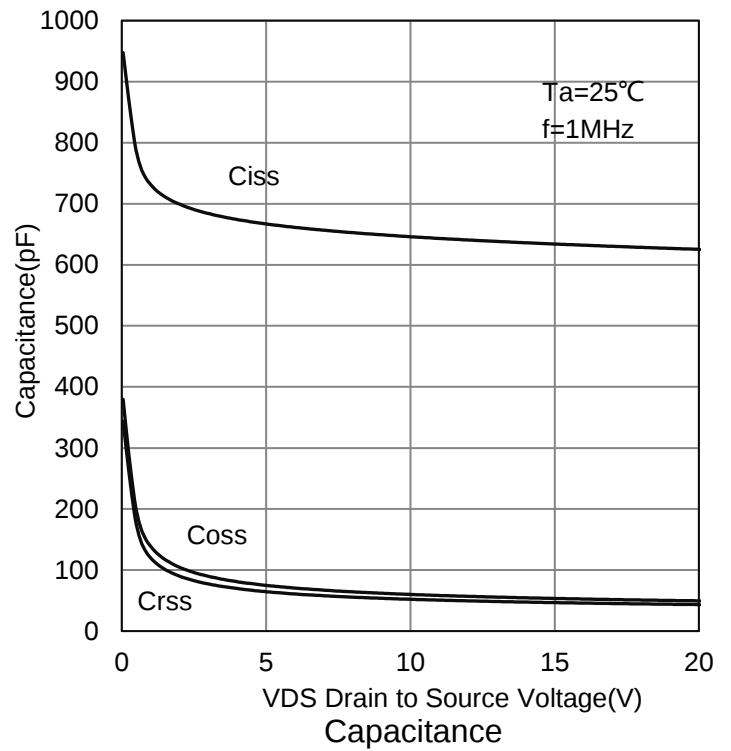
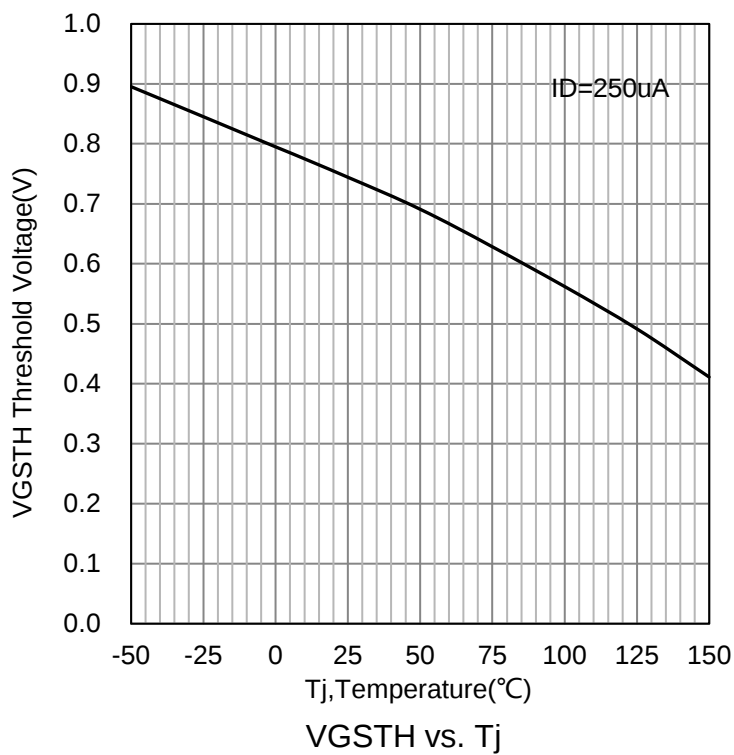
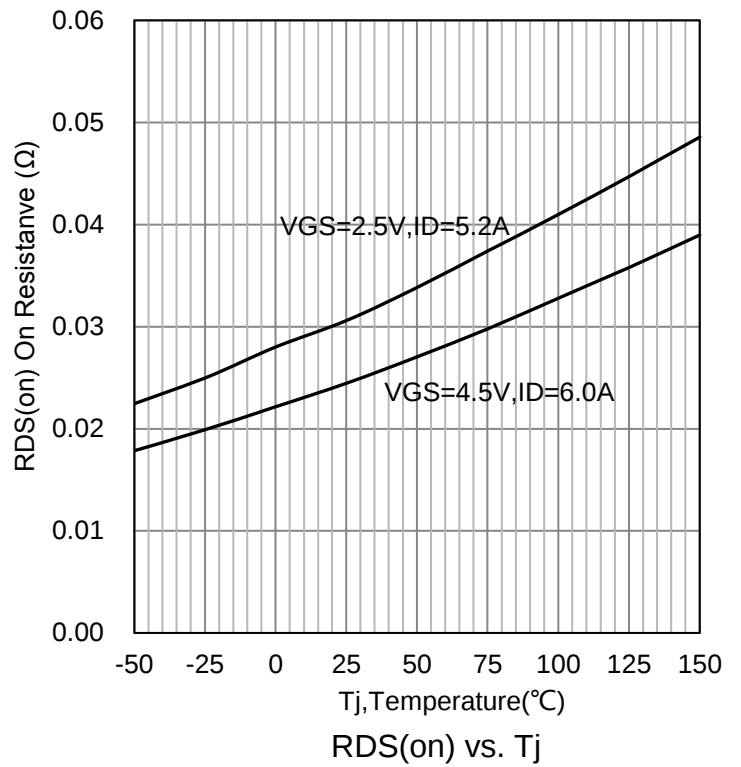
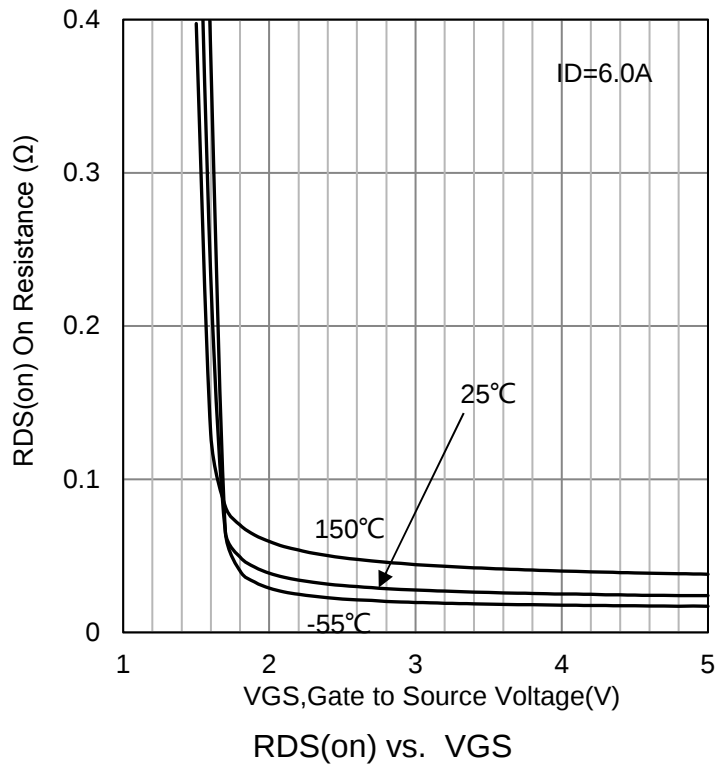
Characteristic	Symbol	Min.	Typ.	Max.	Unit
Static					
Drain–Source Breakdown Voltage (VGS = 0, ID = 250μA)	V(BR)DSS	20	-	-	V
Zero Gate Voltage Drain Current (VDS=20V, VGS=0V)	IDSS	-	-	1	μA
Gate–Body Leakage Current (VDS = 0 V, VGS = ±12 V)	IGSS	-	-	±100	nA
Forward Transconductance (VDS = 10 V, ID = 6 A)	gfs	-	5	-	S
Gate Threshold Voltage (VDS = VGS, ID = 250μA)	VGS(th)	0.4	-	0.9	V
Static Drain–Source On–State Resistance (VGS = 2.5V, ID= 5.2A) (VGS = 4.5 V, ID = 6 A)	RDS(on)	- -	42 33	50 40	mΩ
Dynamic					
Input Capacitance (VGS = 0 V, f = 1.0MHz, VDS= 8 V)	Ciss	-	565	-	pF
Output Capacitance (VGS = 0 V, f = 1.0MHz, VDS= 8 V)	Coss	-	105	-	pF
Reverse Transfer Capacitance (VGS = 0 V, f = 1.0MHz, VDS= 8 V)	Crss	-	75	-	pF
Total Gate Charge	(VDS = 10V, ID = 6A, VGS = 4.5V)	Qg	-	5	nC
Gate–Source Charge		Qgs	-	1	
Gate–Drain Charge		Qgd	-	1.5	
Turn-On Delay Time	(VDD = 10V, ID = 1A, VGS = 4.5V, RG = 6 Ω)	td(on)	-	8	ns
Rise Time		tr	-	10	
Turn-Off Delay Time		td(off)	-	22	
Fall Time		tf	-	6	
Max. Diode Forward Current	IS	-	-	1.7	A
Diode Forward Voltage (VGS = 0 V, IS = 1.7 A)	VSD	-	-	1.2	V

2. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

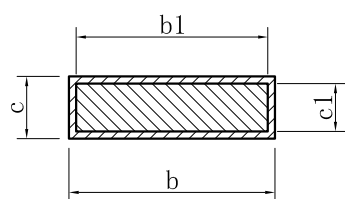
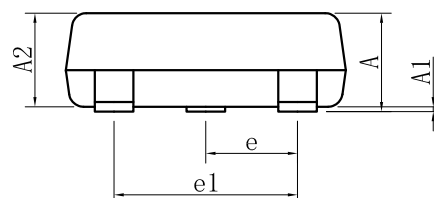
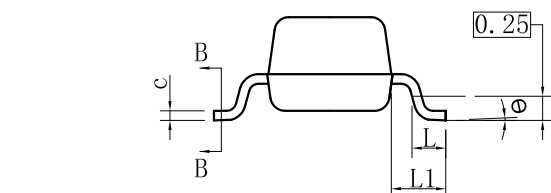
5.ELECTRICAL CHARACTERISTICS CURVES



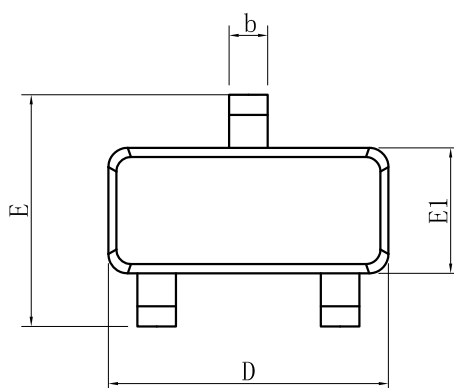
5.ELECTRICAL CHARACTERISTICS CURVES (Con.)



6.OUTLINE AND DIMENSIONS



SECTION B-B

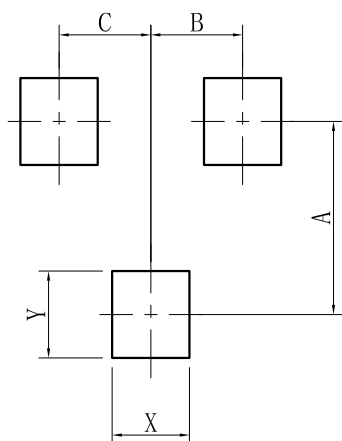


SOT23			
DIM	MIN	NOR	MAX
A	0.89	-	1.12
A1	0.01	-	0.10
A2	0.88	0.95	1.02
b	0.30	-	0.50
b1	0.30	0.40	0.45
c	0.08	-	0.20
c1	0.08	0.10	0.16
D	2.80	2.90	3.04
E	2.10	-	2.64
E1	1.20	1.30	1.40
e	0.95BSC		
e1	1.90BSC		
L	0.40	0.46	0.60
L1	0.54REF		
θ	0°	-	8°
All Dimensions in mm			

GENERAL NOTES

- 1.Top package surface finish $Ra0.4 \pm 0.2\mu m$
- 2.Bottom package surface finish $Ra0.7 \pm 0.2\mu m$
- 3.Side package surface finish $Ra0.4 \pm 0.2\mu m$

7.SOLDERING FOOTPRINT



SOT23	
DIM	(mm)
X	0.80
Y	0.90
A	2.00
B	0.95
C	0.95

DISCLAIMER

- Curve guarantee in the specification. The curve of test items with electric parameter is used as quality guarantee. The curve of test items without electric parameter is used as reference only.
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